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## AMENDMENT TO THE CLAIMS:

The following claim set replaces all prior versions, and listings, of claims in the application:

- 1. (currently amended) Process for preparing a flame retardant polyamide compound comprising melt-mixing of a composition comprising at least a polyamide polymer having a weight-average molecular weight of at least 10.000 g/mol and a flame retardant, eharaeterized in thet wherein the composition comprises an amount of 0.1-30 wt%, relative to the total weight of polyamide, of a polyamide oligomer having (1) a weight-average molecular weight of at most 7.500 g/mol, and (2) a lower melting point than the polyamide polymer, with the proviso that the composition that is melt-mixed does not consist of:
  - 100 parts by weight of a polyamide polymer, 0.001-10 parts by weight of a
    polyamide oligomer with a molecular weight of 5000 or less and having
    hydrocarbon radicals with 5-30 carbons as the terminals, and 1-25 parts
    by weight of a triazine flame retardant;
  - ii) 100 parts by weight of a polyamide-6, 6 polymer, 15 parts by weight of a polyamide oligomer with a molecular weight of 1000 and consisting of the condensation product of stearic acid, ethylenediamine, and sebacic acid, and 7 parts by weight of melamine cyanuric acid; or
  - iii) 100 parts by weight of a polyamide-6 polymer, 0.5 parts by weight of polyamide oligomer with a molecular weight of 1200 and consisting of the condensation product of stearyl amine, ethylenediamine, and sebacic acid, and 27 parts by weight melamine cyanuric acid.
- (original) Process according to claim 1, wherein the polyamide polymer is a polyamide with a melting temperature of at least 260°C.

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- (currently amended) Process according to <u>claim 1</u>, wherein the polyamide oligomer is a polyamide with a melting temperature of at least 260°C.
- (previously presented) Process according to claim 1, wherein the flame retardant is halogen-free flame retardant.
- (previously presented) Process according to claim 1, wherein the flame retardant is a halogenated organic compound.
- (previously presented) Process according to claim 1, wherein the polyamide composition comprises a reinforcing component.
- 7. (currently amended) Flame retardant polyamide compound comprising a polyamide polymer having a weight-average molecular weight of at least 10.000 g/mol and a an amount of 1-100 wt. %, relative to the total weight of polyamide, of a flame retardant, ehereeterized in thet wherein the compound comprises an amount of 0.1-30 wt. %, relative to the total weight of polyamide, of a polyamide derived from a polyamide oligomer having (1) a molecular weight of at most 7500 g/mol, and (2) a lower melting point than the polyamide polymer, with the proviso that the compound does not consist of:
  - 100 parts by weight of a polyamide polymer, 0.001-10 parts by weight of a
    polyamide oligomer with a molecular weight of 5000 or less and having
    hydrocarbon radicals with 5-30 carbons as the terminals, and 1-25 parts
    by weight of a triazine flame retardant;
  - ii) 100 parts by weight of a polyamide-6, 6 polymer, 15 parts by weight of a polyamide oligomer with a molecular weight of 1000 and consisting of the condensation product of stearic acid, ethylenediamine, and sebacic acid, and 7 parts by weight of melamine cyanuric acid; or
  - 100 parts by weight of a polyamide-6 polymer, 0.5 parts by weight of polyamide oligomer with a molecular weight of 1200 and consisting of the

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condensation product of stearyl amine, ethylenediamine, and sebacic acid, and 27 parts by weight melamine cyanuric acid.

 (original) A molded part comprising Use of a polyamide compound according to claim 7 8 for the preparation of a molded part.